

**FLIP CHIP ARRAY****APPLICATIONS**

- ✓ Cellular Phones
- ✓ Personal Digital Assistant (PDA)
- ✓ Ground Positioning System (GPS)
- ✓ SMART & PCMCIA Cards

**IEC COMPATIBILITY (EN61000-4)**

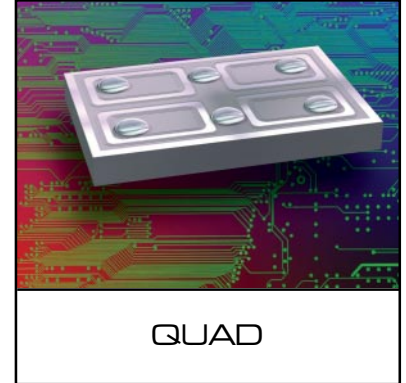
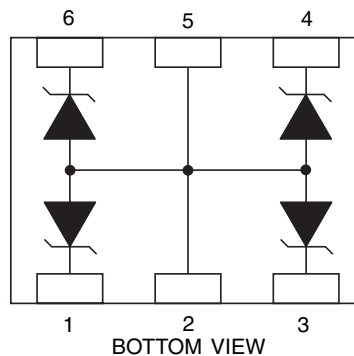
- ✓ 61000-4-2 (ESD): Air - 15kV, Contact - 8kV
- ✓ 61000-4-4 (EFT): 40A - 5/50ns
- ✓ 61000-4-5 (Surge): 24A, 8/20 $\mu$ s - Level 2(Line-Gnd) & Level 3(Line-Line)

**FEATURES**

- ✓ ESD Protection > 25 kilovolts
- ✓ 300 Watts Peak Pulse Power per Line ( $t_p = 8/20\mu$ s)
- ✓ Protects up to Four (4) Unidirectional Lines
- ✓ RoHS Compliant in Lead-Free Versions

**MECHANICAL CHARACTERISTICS**

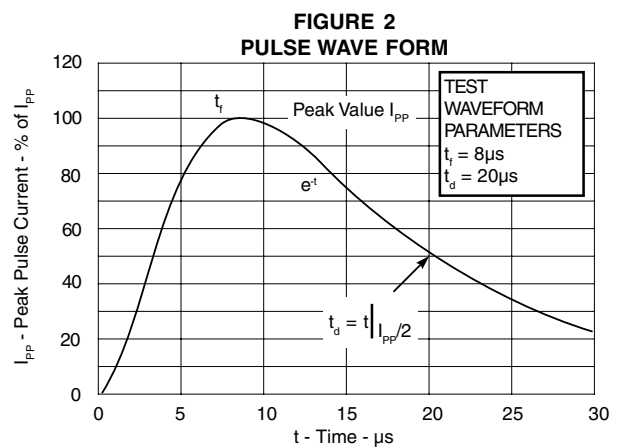
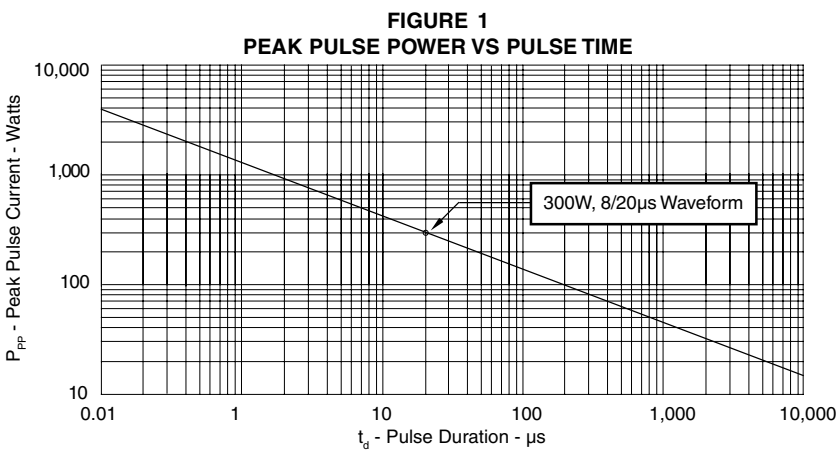
- ✓ Weight 0.73 milligrams (Approximate)
- ✓ Available in Tin-Lead or Lead-Free Plating
- ✓ Solder Reflow Temperature:
  - Tin-Lead - Sn/Pb, 85/15: 240-245°C
  - Lead-Free - Sn/Ag/Cu, 96/3.5/0.5: 260-270°C
- ✓ Flammability Rating UL 94V-0
- ✓ 8mm Plastic & Paper Tape and Reel Per EIA Standard 481
- ✓ Device Marking On Reel
- ✓ Top Contacts: Solder Bump 0.004" in Height (Nominal)

**PIN CONFIGURATION**

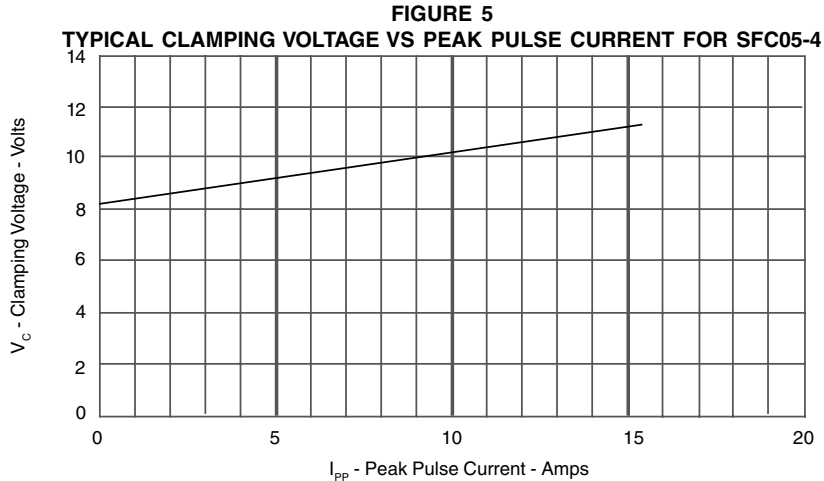
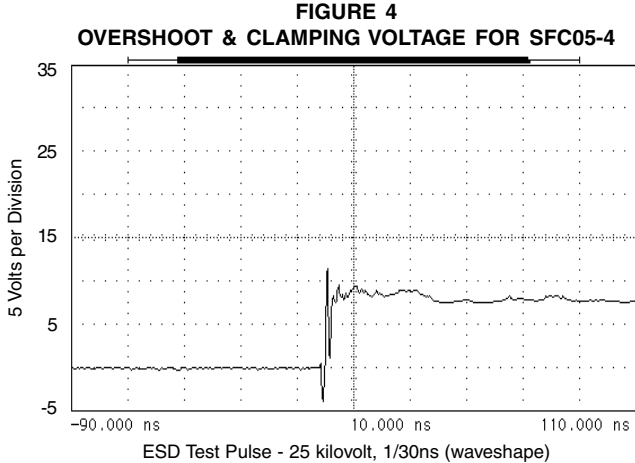
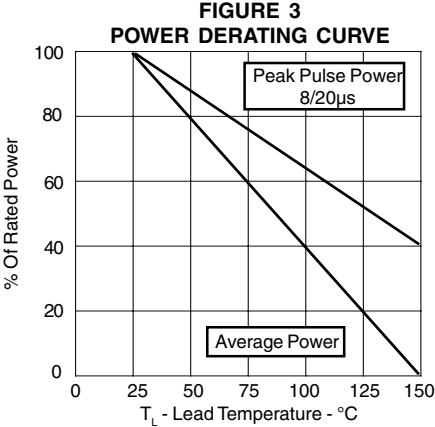
DEVICE CHARACTERISTICS

MAXIMUM RATINGS @ 25°C Unless Otherwise Specified			
PARAMETER	SYMBOL	VALUE	UNITS
Peak Pulse Power ( $t_p = 8/20\mu s$ ) - See Figure 1	$P_{PP}$	300	Watts
Operating Temperature	$T_J$	-55°C to 150°C	°C
Storage Temperature	$T_{STG}$	-55°C to 150°C	°C

ELECTRICAL CHARACTERISTICS PER LINE @ 25°C Unless Otherwise Specified						
PART NUMBER	RATED STAND-OFF VOLTAGE	MINIMUM BREAKDOWN VOLTAGE	MAXIMUM CLAMPING VOLTAGE (See Fig. 2)	MAXIMUM CLAMPING VOLTAGE (See Fig. 2)	MAXIMUM LEAKAGE CURRENT	TYPICAL CAPACITANCE
	$V_{WM}$ VOLTS	@ 1mA $V_{(BR)}$ VOLTS	@ $I_p = 5A$ $V_C$ VOLTS	@ 8/20 $\mu s$ $V_C @ I_{PP}$	@ $V_{WM}$ $I_D$ $\mu A$	@ 0V, 1 MHz $C_i$ pF
SFC05-4	5.0	6.0	9.5	11.0V @ 24A	10	150



GRAPHS

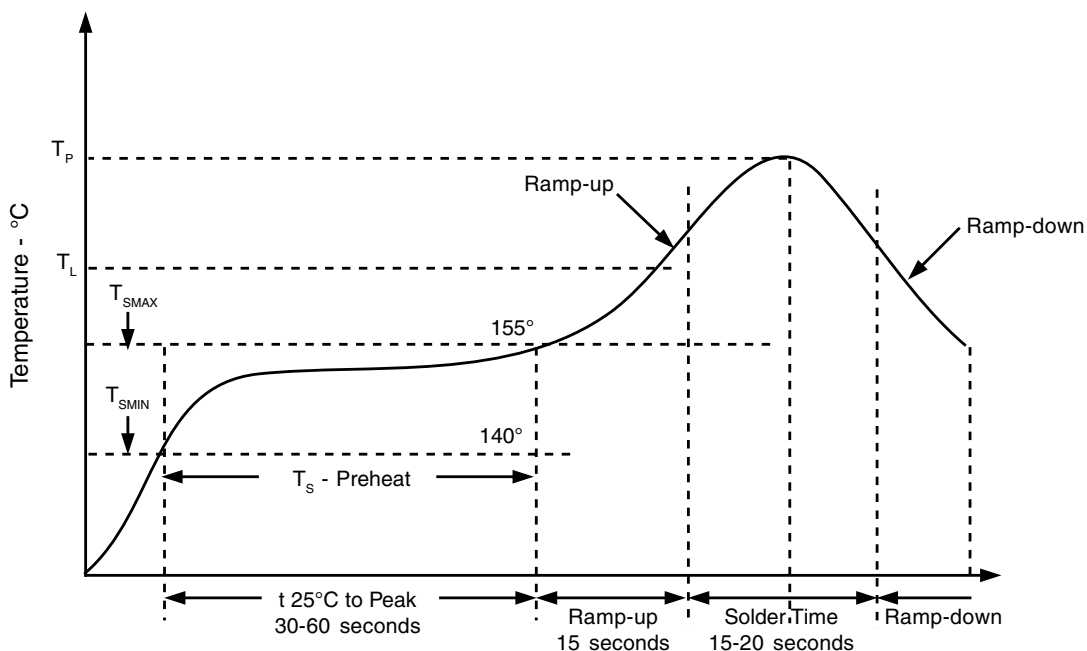
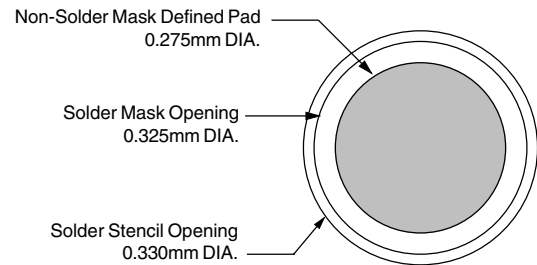


APPLICATION INFORMATION

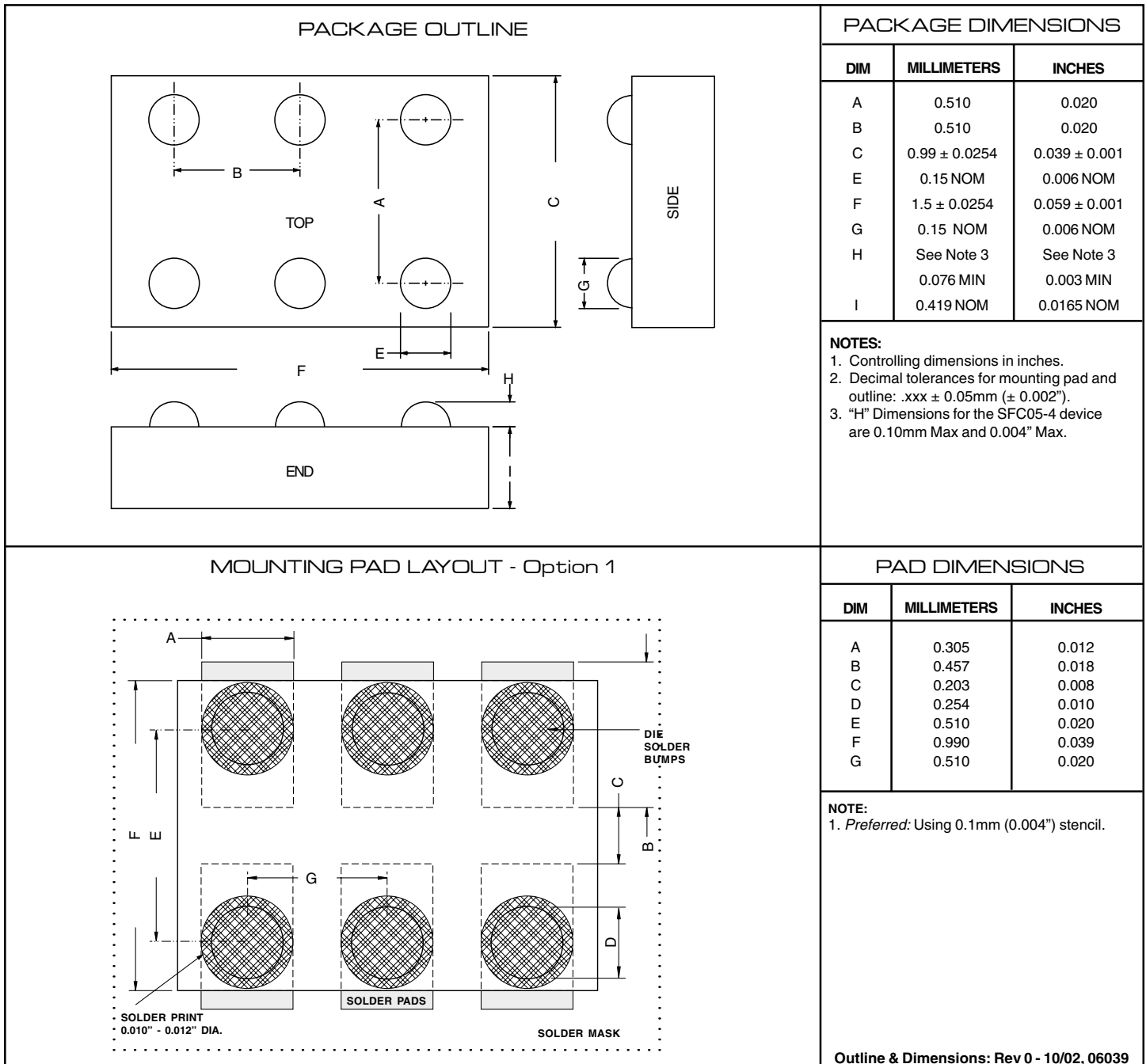
PRINTED CIRCUIT BOARD RECOMMENDATIONS	
PARAMETER	VALUE
Pad Size on PCB	0.275mm
Pad Shape	Round
Pad Definition	Non-Solder Mask Defined Pads
Solder Mask Opening	0.325mm Round
Solder Stencil Thickness	0.150mm
Solder Stencil Aperture Opening (laser cut, 5% tapered walls)	0.330mm Round
Solder Paste Type	No Clean
Pad Protective Finish	OSP(Entek Cu Plus 106A)
Tolerance - Edge To Corner Ball	±50µm
Solder Ball Side Coplanarity	±20µm
Maximum Dwell Time Above Liquidous (183°C)	60 Seconds
Soldering Maximum Temperature	270°C

REQUIREMENTS
<p><b>Temperature:</b></p> <p><math>T_P</math> for Lead-Free (SnAgCu): 260-265°C</p> <p><math>T_P</math> for Tin-Lead: 240-245°C</p> <p>Preheat time and temperature depends on solder paste and flux activation temperature, component size, weight, surface area &amp; plating.</p>

RECOMMENDED NON-SOLDER MASK DEFINED PAD ILLUSTRATION

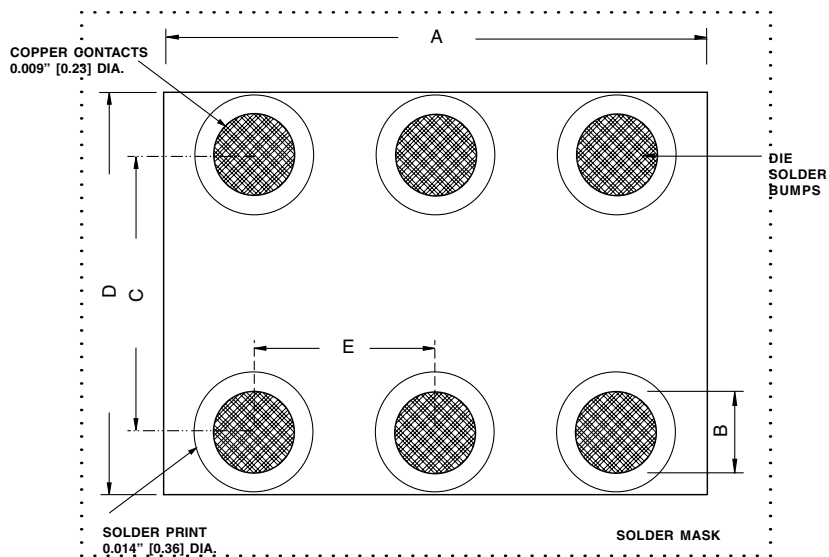


## PACKAGE OUTLINE & DIMENSIONS



## PACKAGE OUTLINE & DIMENSIONS

MOUNTING PAD LAYOUT - Option 2



### PACKAGE DIMENSIONS

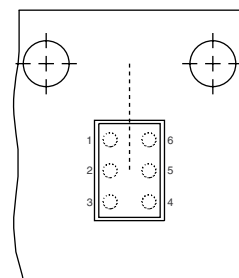
DIM	MILLIMETERS	INCHES
A	1.499	0.059
B	0.152 NOM	0.006 NOM
C	0.510	0.020
D	0.990	0.039
E	0.510	0.020

### NOTES:

1. Controlling dimensions in inches.
2. Decimal tolerances for mounting pad and outline: .xxx ± 0.05mm (± 0.002").
3. Preferred: Using 0.1mm (0.004") stencil.

Outline & Dimensions: Rev 0 - 10/02, 06039

### TAPE & REEL ORIENTATION



### NOTE:

1. Top view of tape. Solder bumps are face down in tape package.

### TAPE & REEL ORDERING NOMENCLATURE

1. Surface mount product is taped and reeled in accordance with EIA 481.
2. 8mm Plastic Tape: 7 Inch Reels - 5,000 pieces per reel. Ordering Suffix: -T75-1 (i.e., SFC05-4-T75-1).
3. 8mm Paper Tape: 7 Inch Reels - 5,000 pieces per reel. Ordering Suffix: -T75-2 (i.e., SFC05-4-T75-2).
4. Suffix - LF = Lead-Free, i.e., SFC05-4-LF-T75-2.

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